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Robert
Response

CERTIFICATE OF MAILING

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Signed: Stephen E. Baldwin Date: March 1, 2000
Stephen E. Baldwin, Reg. No. 27,769



IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Inventor: Pedersen et al

Art Unit: 2103

Serial No.: 08/834,798

Examiner: SPARKS, D.

Filed: 04/07/97

For: A CONDUCTIVE EPOXY FLIP-CHIP
PACKAGE AND METHOD

PRELIMINARY AMENDMENT

Assistant Commissioner for Patents
Washington, D. C. 20231

Sir:

This Preliminary Amendment is submitted in order to place the present application in better condition for examination.

REMARKS

The present application is a Continued Prosecution Application of parent application Serial No. 08/374,421, filed January 19, 1995, now U.S. Patent No. 5,657,206, issued August 12, 1997.

The Examiner rejected Claims 1-4, 8-10, 14 and 16 under 35 USC 102(e) as being